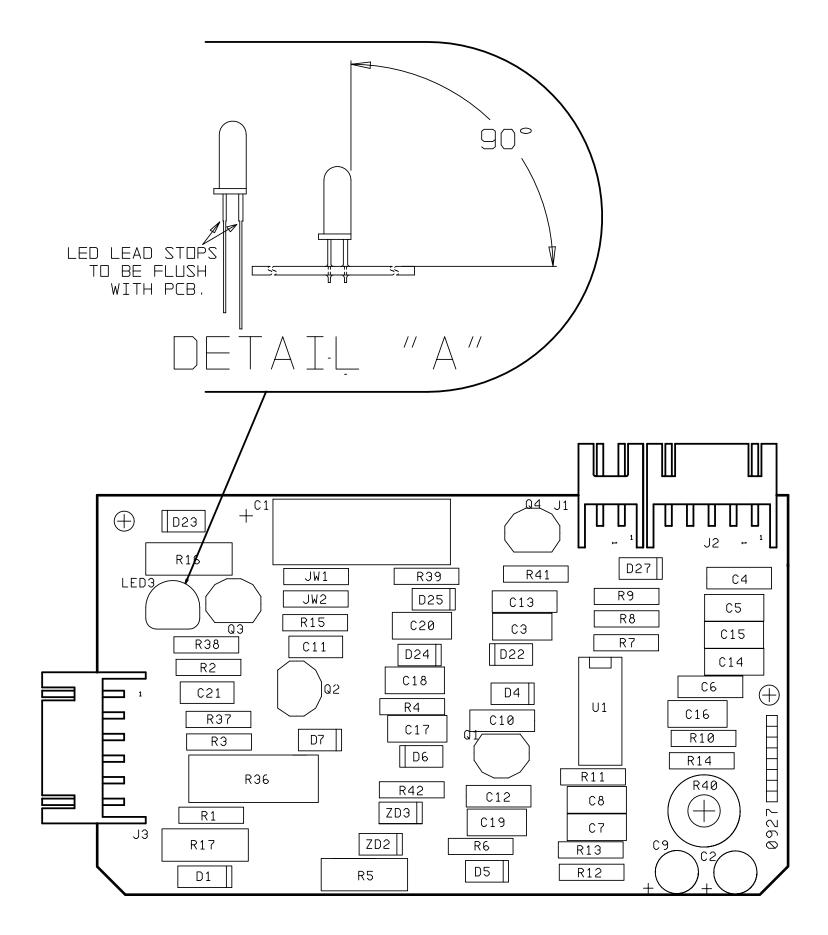


NO .	ECO NO.	REVISIONS	DATE/BY
X	006188	SEE SHEET 1	7/20/00 BPP



VNTES:

- 1. REFER TO SCHEMATIC DIAGRAM AND PARTS LIST FOR REFERENCE DESIGNATIONS AND COMPONENT VALUES
- 2. MAXIMUM HEIGHT FOR ANY COMPONENT TO BE .35" EXCEPT FOR LED3.
- 3. MAXIMUM COMPONENT LEAD PROJECTION TO BE .085".
- 4. SOLDERING SHALL BE IN ACCORDANCE WITH IPC-S-815.
- 5. ASSEMBLIES TO BE CLEANED OF FLUX AND OTHER CONTAMINANTS AFTER SOLDERING.
- 6. LED3 TO BE VERTICAL TO PCB DURING SOLDERING PROCESS (SEE DETAIL A).
- 7. CONNECTORS TO BE FLUSH TO PCB DURING SOLDERING PROCESS.

